

CR02AM-8

Thyristor

Low Power Use

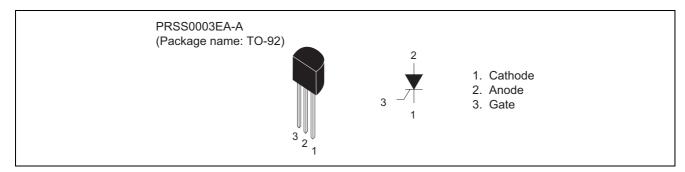
REJ03G0351-0200 Rev.2.00 Mar.01.05

Features

• $I_{T(AV)}: 0.3 A$

• Planar Passivation Type

Outline



Applications

Solid state relay, leakage protector, fire alarm, timer, ring counter, electric blanket, protective circuit for acoustic equipment, strobe flasher, and other general purpose control applications

Maximum Ratings

Parameter	Symbol	Voltage class	l lmi4
Farameter	Symbol	8	Unit
Repetitive peak reverse voltage	V_{RRM}	400	V
Non-repetitive peak reverse voltage	V_{RSM}	500	V
DC reverse voltage	V _{R (DC)}	320	V
Repetitive peak off-state voltage ^{Note1}	V_{DRM}	400	V
DC off-state voltage ^{Note1}	V _{D (DC)}	320	V

Parameter	Symbol	Ratings	Unit	Conditions
RMS on-state current	I _{T (RMS)}	0.47	Α	
Average on-state current	I _{T (AV)}	0.3	А	Commercial frequency, sine half wave 180° conduction, Ta = 30°C
Surge on-state current	I _{TSM}	10	А	60Hz sine half wave 1 full cycle, peak value, non-repetitive
I ² t for fusing	l ² t	0.4	A ² s	Value corresponding to 1 cycle of half wave 60Hz, surge on-state current
Peak gate power dissipation	P _{GM}	0.1	W	
Average gate power dissipation	P _{G (AV)}	0.01	W	
Peak gate forward voltage	V_{FGM}	6	V	
Peak gate reverse voltage	V_{RGM}	6	V	
Peak gate forward current	I _{FGM}	0.1	Α	
Junction temperature	Tj	- 40 to +125	°C	
Storage temperature	Tstg	- 40 to +125	°C	
Mass	_	0.23	g	Typical value

Notes: 1. With gate to cathode resistance $R_{GK} = 1 \text{ k}\Omega$.

Electrical Characteristics

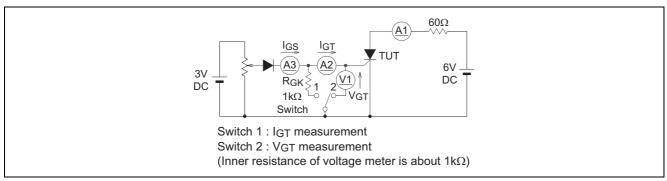
Parameter	Symbol	Min.	Тур.	Max.	Unit	Test conditions
Repetitive peak reverse current	I _{RRM}	_	_	0.1	mA	Tj = 125°C, V _{RRM} applied
Repetitive peak off-state current	I _{DRM}	_	_	0.1	mA	$Tj = 125$ °C, V_{DRM} applied, $R_{GK} = 1 \text{ k}\Omega$
On-state voltage	V _{TM}	_	_	1.6	V	Ta = 25°C, I _{TM} = 0.6 A, instantaneous value
Gate trigger voltage	V _{GT}	_	_	0.8	V	$Tj = 25$ °C, $V_D = 6$ V, $I_T = 0.1$ A ^{Note3}
Gate non-trigger voltage	V_{GD}	0.2	_	_	V	$Tj = 125^{\circ}C, V_D = 1/2 V_{DRM},$ $R_{GK} = 1 k\Omega$
Gate trigger current	I _{GT}	1	_	100 ^{Note2}	μΑ	$Tj = 25$ °C, $V_D = 6$ V, $I_T = 0.1$ A ^{Note3}
Holding current	I _H	_	_	3	mA	$Tj = 25$ °C, $V_D = 12$ V, $R_{GK} = 1$ k Ω
Thermal resistance	R _{th (j-a)}	_	_	180	°C/W	Junction to ambient

Notes: 2. If special values of I_{GT} are required, choose item D or E from those listed in the table below if possible.

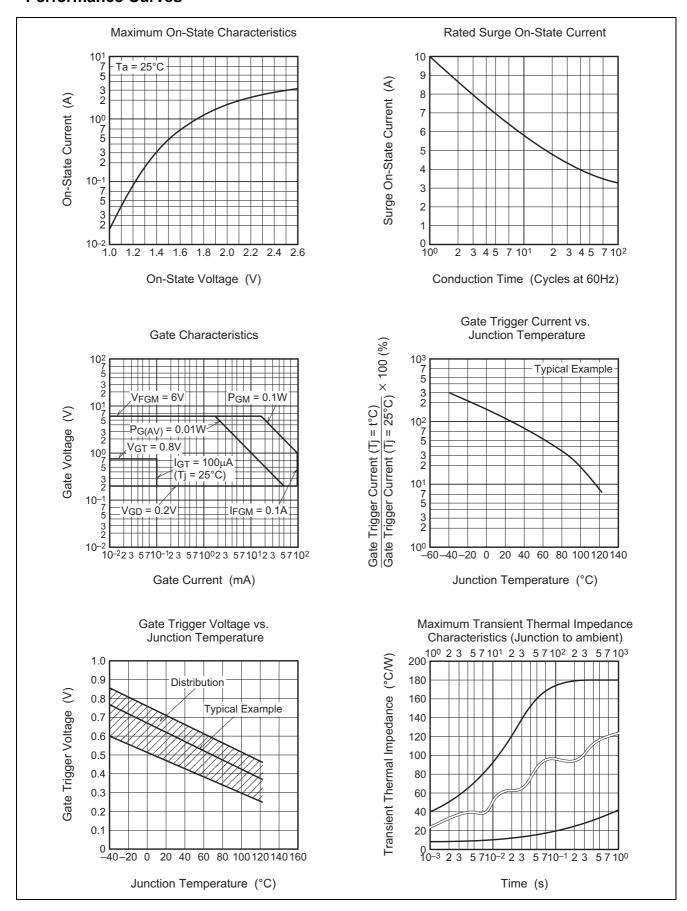
	Item	Α	В	С	D	E
Γ	I _{GT} (μA)	1 to 30	20 to 50	40 to 100	1 to 50	20 to 100

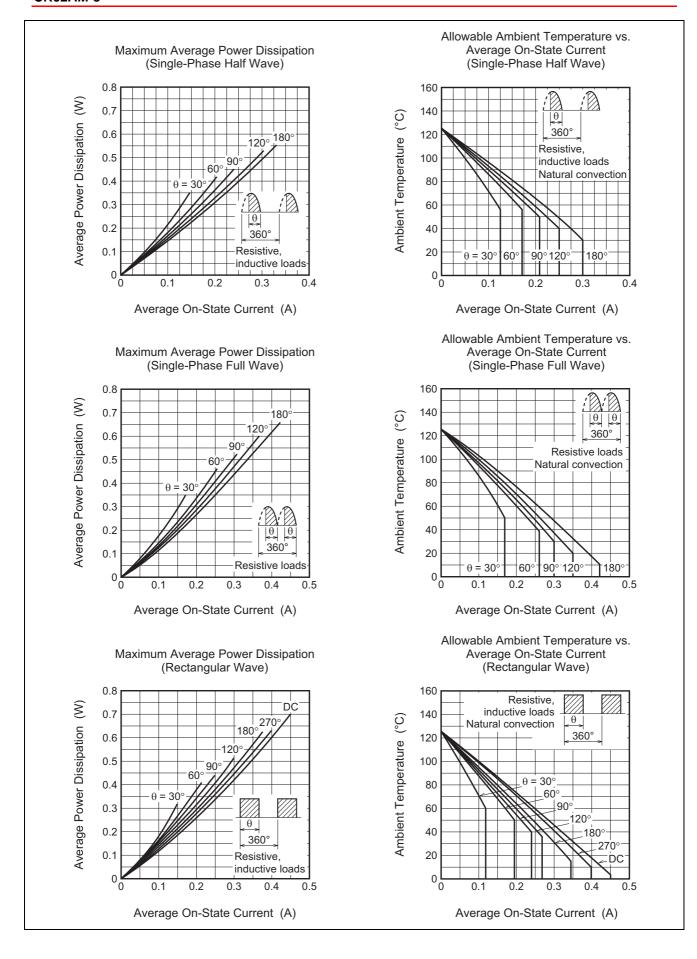
The above values do not include the current flowing through the 1 $k\Omega$ resistance between the gate and cathode.

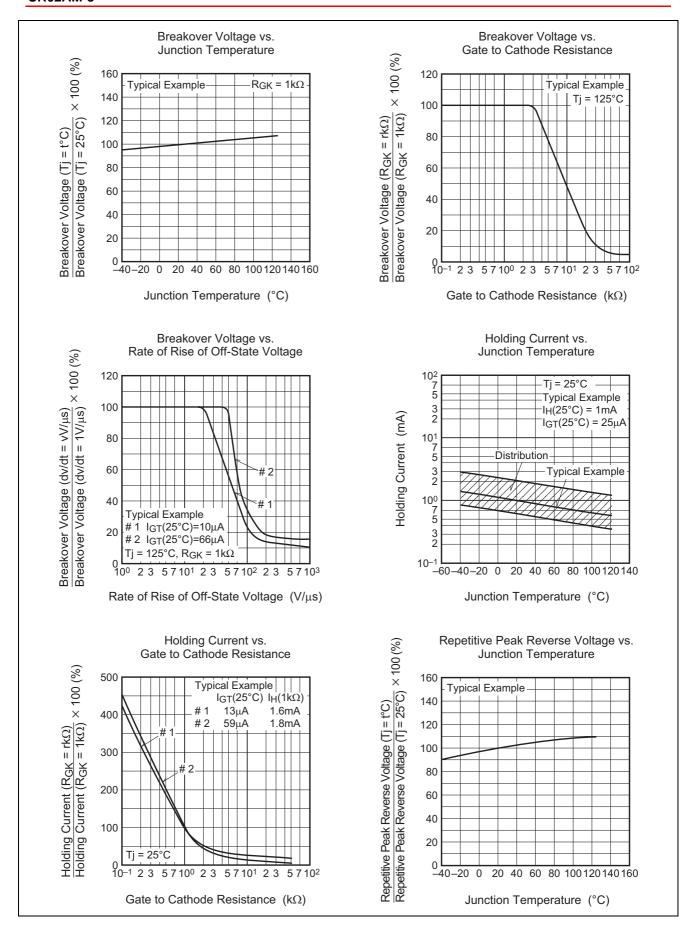
3. I_{GT} , V_{GT} measurement circuit.

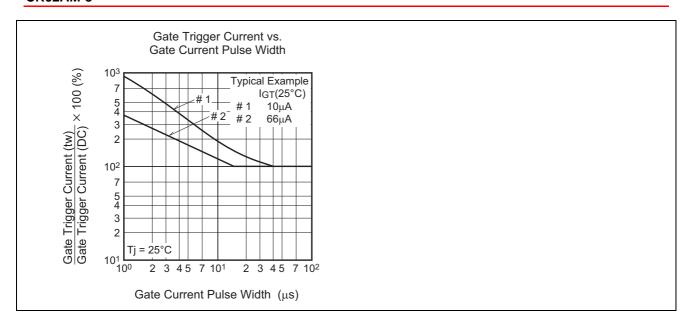


Performance Curves

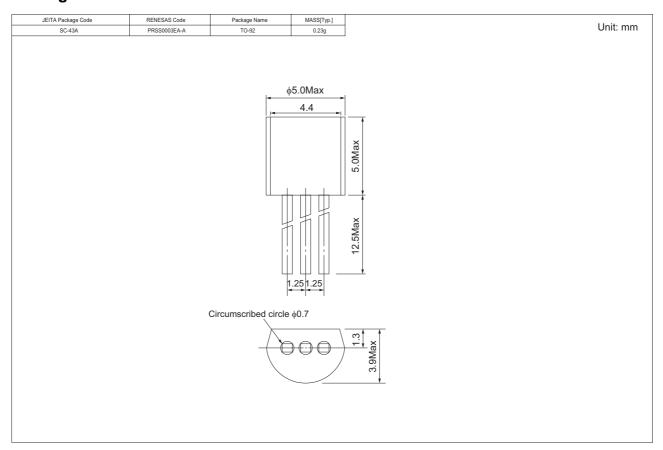








Package Dimensions



Order Code

Lead form	Standard packing	Quantity	Standard order code	Standard order code example
Straight type	Vinyl sack	500	Type name	CR02AM-8
Lead form	Vinyl sack	500	Type name – Lead forming code	CR02AM-8-A6
Form A8	Taping	2000	Type name – TB	CR02AM-8-TB

Note: Please confirm the specification about the shipping in detail.

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